

N-Channel Silicon Carbide MOSFET

Rev.02 - 17 May 2023

Product data sheet

1. General description

Silicon Carbide MOSFET in a TO247-4L plastic package, designed for high frequency, high efficiency systems.

2. Features and benefits

- Separate driver source pin
- Low on-resistance
- Fast switching speed
- OV turn-off gate voltage for simple gate drive
- 100% UIS Tested
- Easy to parallel
- Controllable dV/dt for optimized EMI
- Reduced cooling requirements
- RoHS compliant

3. Applications

- Switch Mode Power Supplies
- UPS
- Solar string inverter and solar optimizer
- EV Charger
- Motor Drives

4. Quick reference data

	lick reference data						
Symbol	Parameter	Conditions	Notes	Values		Unit	
Absolute	maximum rating						
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		1200		V	
I _D	drain current	V _{GS} = 18 V; T _{mb} = 25 °C			73		А
P _{tot}	total power dissipation	T _{mb} = 25 °C		405		W	
Tj	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$R_{DS(on)}$	drain-source on-state resistance	V _{GS} = 15 V; I _D = 33 A; T _j = 25 °C		-	40	55	mΩ
Dynamic	characteristics						
Q _{G(tot)}	total gate charge	$I_D = 33 \text{ A}; V_{DS} = 800 \text{ V}; V_{GS} = -4 \text{ V}/18 \text{ V};$		-	116	-	nC
Q _{GD}	gate-drain charge	T _j = 25 °C		-	19	-	nC
Source-d	rain diode	·					_
Q _r	recovered charge	I _{SD} = 33 A; di/dt = 500 A/μs; V _{DS} = 400 V; T _i = 25 °C		-	174	-	nC



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5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	D	drain		D
2	S	source		
3	SS	source sense		
4	G	gate		sym301 S
mb	D	mounting base; connected to drain		

6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WNSC2M40120R	TO247-4L	WNSC2M40120R6Q	Tube	30	TO247N-4L	17-Dec-2021		

7. Marking

Table 4. Marking codes	
Type number	Marking codes
WNSC2M40120R	WNSC2M 40120R

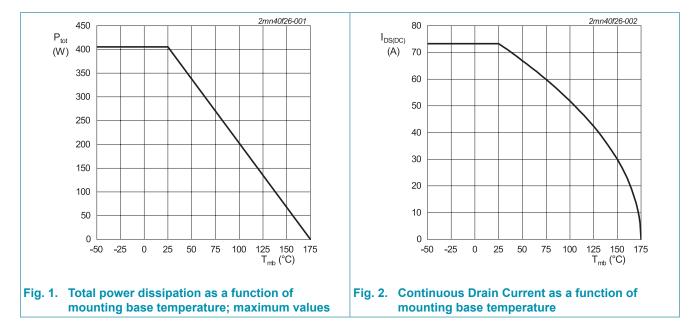
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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		1200	V
$V_{\text{GS,max}}$	gate-source voltage			-12 to 22	V
$V_{\text{GS,op}}$	gate-source voltage			-4 to 18	V
P _{tot}	total power dissipation	T _{mb} = 25 °C		405	W
I _D	drain current	V _{GS} = 18 V; T _{mb} = 25 °C		73	А
		V _{GS} = 18 V; T _{mb} = 100 °C		52	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		100	А
E _{as}	single pulse drain-to- source avalanche	$I_{AS} = 24 \text{ A}; \text{ L} = 1 \text{ mH}; \text{ V}_{DD} = 100 \text{ V};$ $T_j = 25 \text{ °C}$		288	mJ
T _{stg}	storage temperature			-55 to 175	°C
T _j	junction temperature			-55 to 175	°C
T _{sld(M)}	peak soldering temperature			260	°C



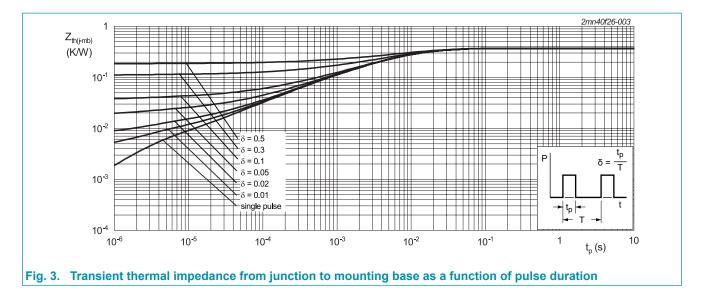
9. Thermal & Mechanical characteristics

Table 6. Thermal & Mechanical characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base			-	-	0.37	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air		-	40	-	K/W
M_{d}	Mounting torque	M3 or 6 - 32 screw		-	-	0.6	Nm

Note: It is recommended that a metal washer is inserted between screw head and mounting tab. Do not use self-tapping screws.

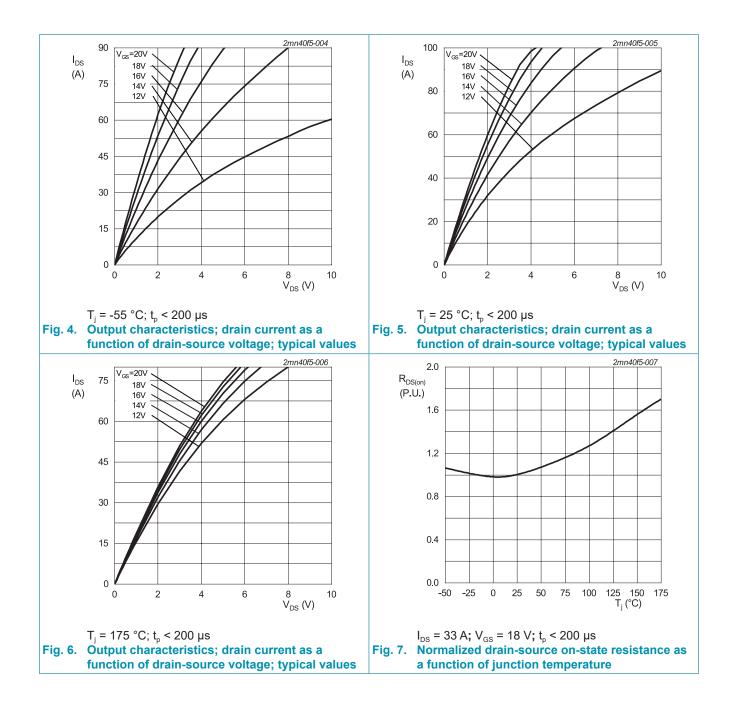
Device is ESD sensitive. Handling precautions are recommanded.

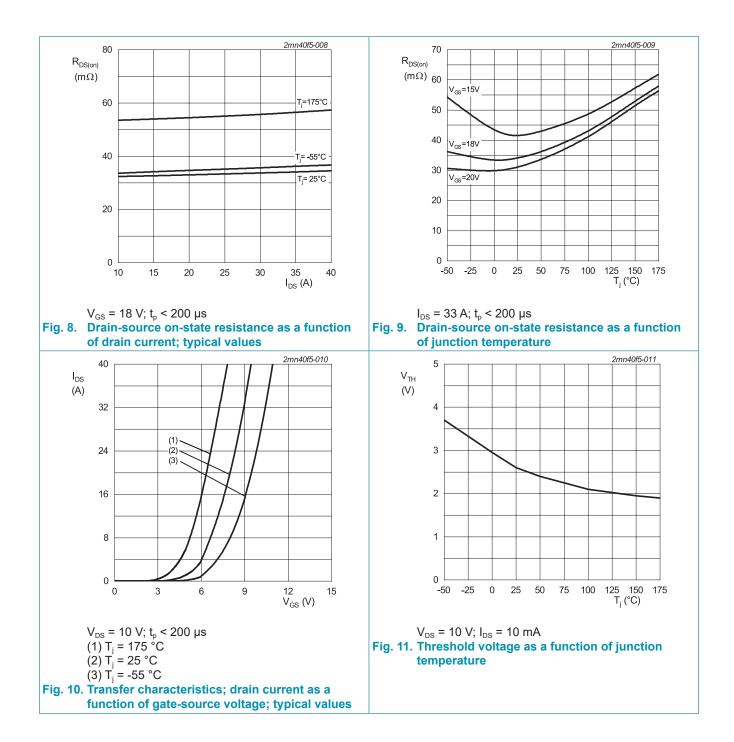


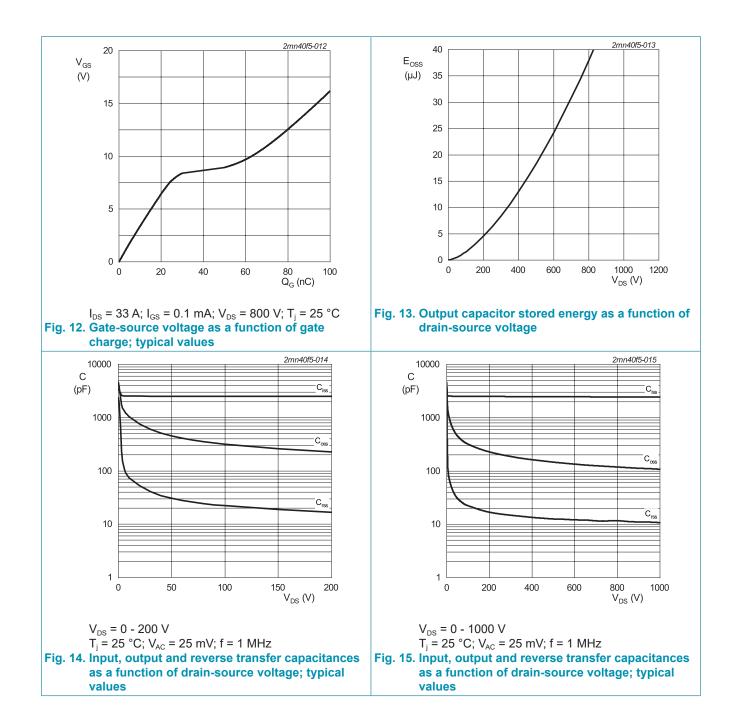
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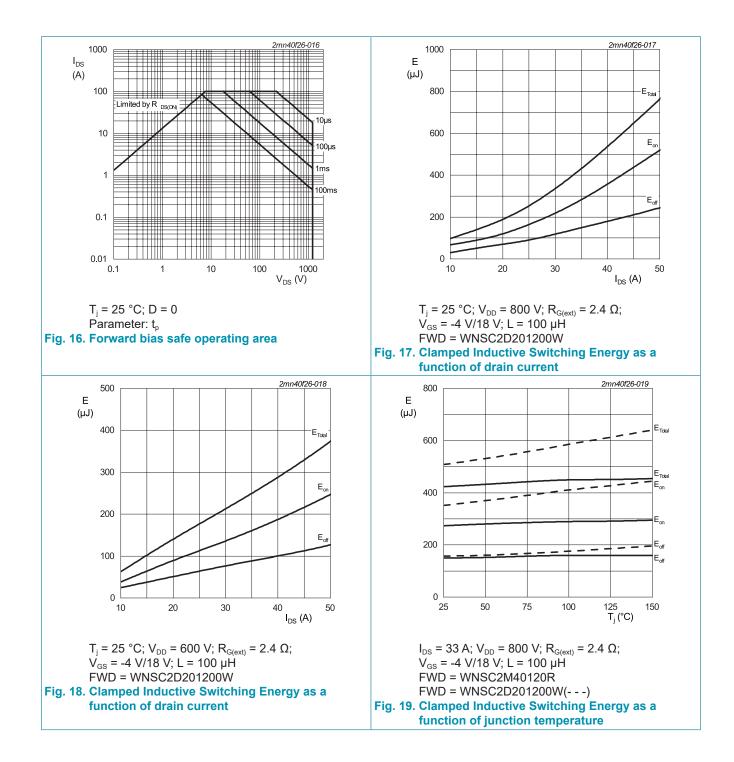
10. Characteristics

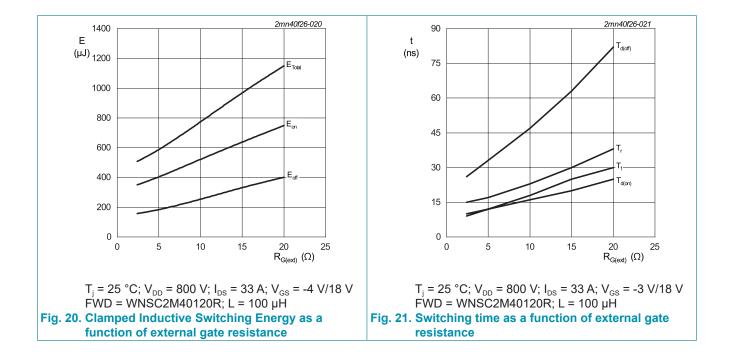
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
	aracteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	I_{D} = 100 µA; V_{GS} = 0 V; T_{j} = 25 °C		1200	-	-	V
V _{GS(th)}	gate-source threshold	I _D = 10 mA; V _{DS} = 10 V; T _j = 25 °C		1.9	2.6	3.5	V
	voltage	I _D = 10 mA; V _{DS} = 10 V; T _j = 175 °C		-	1.9	-	V
I _{DSS}	drain leakage current	V_{DS} = 1200 V; V_{GS} = 0 V; T_{j} = 25 °C		-	0.2	100	μA
		V _{DS} = 1200 V; V _{GS} = 0 V; T _j = 175 °C		-	2	-	μA
I _{GSS}	gate leakage current	V_{GS} = 22 V; V_{DS} = 0 V; T_j = 25 °C		-	10	100	nA
		V _{GS} = -8 V; V _{DS} = 0 V; T _j = 25 °C		-	10	100	nA
R _{DS(on)}	drain-source on-state	V _{GS} = 15 V; I _D = 33 A; T _j = 25 °C		-	40	-	mΩ
	resistance	V _{GS} = 18 V; I _D = 33 A; T _j = 25 °C		-	35	46	mΩ
		V _{GS} = 18 V; I _D = 33 A; T _j = 175 °C		-	58	-	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C		-	1	-	Ω
g _{fs}	transconductance	V _{DS} = 20 V; I _D = 33 A; T _j = 25 °C		-	24	-	S
Dynamic	characteristics	1					
Q _{G(tot)}	total gate charge	I _D = 33 A; V _{DS} = 800 V; V _{GS} = -4 V/18 V;		-	116	-	nC
Q _{GS}	gate-source charge	T _j = 25 °C		-	42	-	nC
Q _{GD}	gate-drain charge			-	19	-	nC
C _{iss}	input capacitance	$V_{DS} = 1000 \text{ V}; V_{GS} = 0 \text{ V}; \text{ f} = 1 \text{ MHz};$ $T_j = 25 \text{ °C}$		-	2450	-	pF
C _{oss}	output capacitance			-	108	-	pF
C _{rss}	reverse transfer capacitance	-		-	11	-	pF
E _{oss}	Coss stored energy			-	54	-	μJ
t _{d(on)}	turn-on delay time	V_{DS} = 800 V; V_{GS} = -3 V/18 V; $R_{G(ext)}$ = 2.4		-	10	-	ns
t _r	rise time	Ω; I _D = 33 A; L = 100 μH; T _j = 25 °Ć		-	15	-	ns
t _{d(off)}	turn-off delay time			-	26	-	ns
t _f	fall time			-	9	-	ns
E _{on}	turn-on energy (SiC Diode FWD)			-	351	-	μJ
E _{off}	turn-off energy (SiC Diode FWD)			-	157	-	μJ
E _{on}	turn-on energy (Body Diode FWD)			-	273	-	μJ
E _{off}	turn-off energy (Body Diode FWD)			-	150	-	μJ
Source-d	rain diode						
V_{SD}	source-drain voltage	V_{GS} = -4 V; I _F = 17.5 A; T _j = 25 °C		-	4.8	-	V
		V _{GS} = -4 V; I _F = 17.5 A; T _j = 175 °C		-	4.2	-	V
t _{rr}	reverse recovery time	$I_{sD} = 33 \text{ A}; \text{ di/dt} = 500 \text{ A/}\mu\text{s}; \text{ V}_{DS} = 400 \text{ V};$		-	52	-	ns
Q _r	recovered charge	T _j = 25 °C		-	174	-	nC
I _{rrm}	reverse recovery current			-	6.8	-	Α





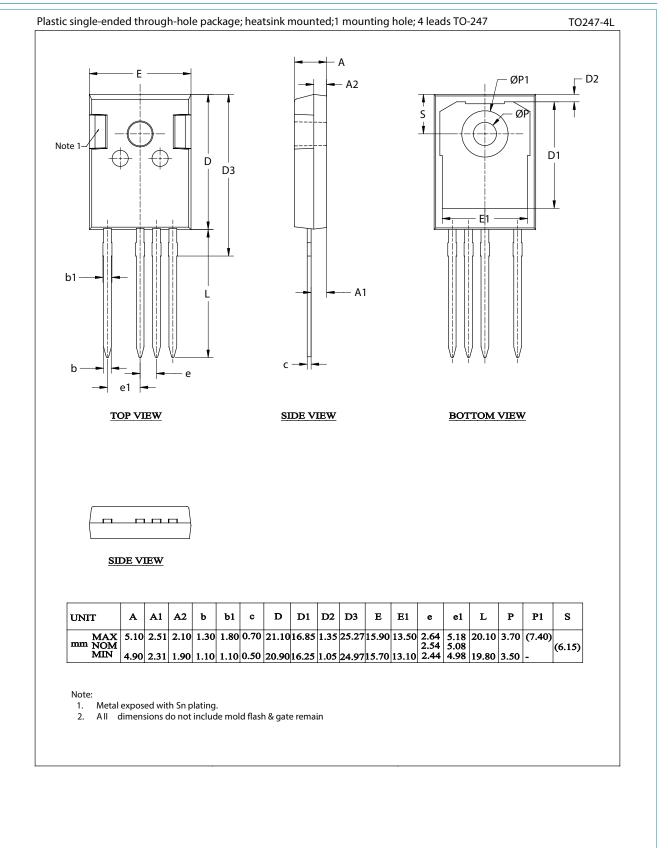






WNSC2M40120R N-Channel Silicon Carbide MOSFET

11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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